

SKiIP 232GH120-210CTV

I. Power section

Absolute maximum ratings		$T_s = 25^\circ\text{C}$ unless otherwise specified	
Symbol	Conditions	Values	Units
IGBT			
V_{CES}	Operating DC link voltage	1200	V
$V_{CC}^{1)}$		900	V
V_{GES}		± 20	V
I_C		$T_s = 25 (70)^\circ\text{C}$	200 (150)
Inverse diode			
$I_F = -I_C$	$T_s = 25 (70)^\circ\text{C}$	200 (150)	A
I_{FSM}	$T_j = 150^\circ\text{C}$, $t_p = 10\text{ms}$; sin	1440	A
I^2t (Diode)	Diode, $T_j = 150^\circ\text{C}$, 10ms	10	kA^2s
$T_j, (T_{stg})$		-40 (-25) ... +150 (125)	$^\circ\text{C}$
V_{isol}	AC, 1min.	3000	V

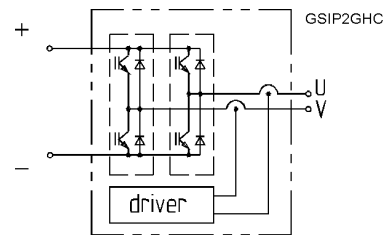
Characteristics $T_s = 25^\circ\text{C}$ unless otherwise specified					
Symbol	Conditions	min.	typ.	max.	Units
IGBT					
V_{CEsat}	$I_C = 175\text{A}$, $T_j = 25 (125)^\circ\text{C}$	-	2,6 (3,1)	3,1	V
V_{CEO}	$T_j = 25 (125)^\circ\text{C}$	-	1,2 (1,3)	1,5 (1,6)	V
r_{CE}	$T_j = 25 (125)^\circ\text{C}$	-	7,5 (10,0)	9,0 (11,5)	$\text{m}\Omega$
I_{CES}	$V_{GE}=0, V_{CE}=V_{CES}, T_j=25(125)^\circ\text{C}$	-	(10)	0,4	mA
$E_{on} + E_{off}$	$I_C=175\text{A}$, $V_{CC}=600\text{V}$ $T_j=125^\circ\text{C}$ $V_{CC}=900\text{V}$	-	-	53 93	mJ mJ
R_{CC-EE}	terminal chip, $T_j = 125^\circ\text{C}$	-	0,50	-	$\text{m}\Omega$
L_{CE}	top, bottom	-	15,0	-	nH
C_{CHC}	per phase, AC-side	-	1,4	-	nF
Inverse diode					
$V_F = V_{EC}$	$I_F = 150\text{A}$; $T_j = 25(125)^\circ\text{C}$	-	2,1 (1,9)	2,6	V
V_{TO}	$T_j = 25 (125)^\circ\text{C}$	-	1,3 (1,0)	1,4 (1,1)	V
r_T	$T_j = 25 (125)^\circ\text{C}$	-	5,0 (6,0)	6,8 (7,8)	$\text{m}\Omega$
E_{RR}	$I_C=175\text{A}$ $V_{CC}=600\text{V}$ $T_j=125^\circ\text{C}$ $V_{CC}=900\text{V}$	-	-	6 8	mJ mJ
Mechanical data					
M_{dc}	DC terminals, SI Units	6	-	8	Nm
M_{ac}	AC terminals, SI Units	13	-	15	Nm
w	SKiIP [®] 2 System w/o heat sink	-	1,9	-	kg
w	heat sink	-	4,7	-	kg
Thermal characteristics (P16 heat sink; 310 m^3/h); "r" reference to temperature sensor					
$R_{thjrlGBT}$	per IGBT	-	-	0,129	K/W
$R_{thjrdiode}$	per diode	-	-	0,375	K/W
R_{thra}	per module	-	-	0,044	K/W
Z_{th}	R_i (mK/W) (max.)	τ_{ai} (s)			
	1 2 3 4	1	2	3	4
IGBT _{jr}	14 99 15 -	1	0,13	0,001	-
diode _{jr}	41 289 45 -	1	0,13	0,001	-
heatsink _{ra}	14,2 19,3 6,8 3,7	262	50	5	0,02

SKiIP[®] 2

SK integrated intelligent Power 4-pack

SKiIP 232GH120-210CTV

Case S2



Features

- SKiIP technology inside
- low loss IGBTs
- CAL diode technology
- integrated current sensor
- integrated temperature sensor
- integrated heat sink
- IEC 60721-3-3 (humidity) class 3K3/IE32 (SKiIP[®] 2 System)
- IEC 68T.1 (climate) 40/125/56 (SKiIP[®] 2 power section)

1) with assembly of suitable MKP capacitor per terminal (SEMIKRON type is recommended)

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SKiiP 232GH120-210CTV

SKiiP 2®

SK integrated intelligent Power

SKiiP 232GH120-210CTV

II. Integrated gate driver

Absolute maximum ratings			
Symbol	Term	Value	Unit
V _{S1}	stabilized 15V power supply	18	V
V _{S2}	unstabilized 24V power supply	30	V
V _{iH}	input signal voltage (high)	15 + 0,3	V
dv/dt	secondary to primary side	75	kV/μs
V _{isolIO}	input / output (AC)	3000	Vac
V _{isol12}	output 1 / output 2 (AC)	1500	Vac
f _{max}	switching frequency	20	kHz
T _{op} (T _{stg})	operating / storage temperature	- 25 ... + 85	°C

Gate driver features

- CMOS compatible inputs
- wide range power supply
- integrated circuitry to sense phase current, heat sink temperature and DC-bus voltage (option)
- short circuit protection
- over current protection
- over voltage protection (option)
- power supply protected against under voltage
- interlock of top/bottom switch
- isolation by transformers
- fibre optic interface (option for GB-types only)
- IEC 68T.1 (climate) 25/85/56 (SKiiP® 2 gate driver)

Electrical characteristics (T _a = 25 °C)				Values				
Symbol	Term				min	typ	max.	Units
V _{S1}	supply voltage stabilized				14,4	15	15,6	V
V _{S2}	supply voltage non stabilized				20	24	30	V
I _{S1}	V _{S1} = 15V	230 + 230*f / f _{max} + 1,3* (I _{AC} /A)						mA
I _{S2}	V _{S2} = 24V	170 + 280*f / f _{max} + 1,0 * (I _{AC} /A)						mA
V _{iT+}	input threshold voltage (High)				11,2	–	–	V
V _{iT-}	input threshold voltage (Low)				–	–	5,4	V
R _{in}	input resistance				–	10	–	kΩ
t _{d(on)IO}	turn-on propagation time (system)				–	1,2	–	μs
t _{d(off)IO}	turn-off propagation time (system)				–	1,6	–	μs
t _{pERRRESET}	error memory reset time				9	–	–	μs
t _{TD}	top/bottom switch: interlock time				–	2,3	–	μs
I _{analogOUT}	8 V corresponds to				–	200	–	A
I _{Vs1outmax}	max. current of 15 V supply voltage (available when supplied with 24V)				–	–	50	mA
I _{AOmax}	output current at pin 15/16/18/19				–	–	5	mA
V _{ol}	logic low output voltage				–	–	0,6	V
V _{oH}	logic high output voltage				–	–	30	V
I _{TRIPSC}	over current trip level (I _{analog OUT} = 10V)				–	250	–	A
I _{TRIPLG}	ground fault protection				–	58	–	A
T _{ip}	over temperature protection				110	–	120	°C
U _{DCTRIP}	trip level of U _{DC} -protection (U _{analog OUT} = 9V); (option)				900	–	–	V

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